



Material Content Data Sheet



Halogen-Free

Sales Product Name	BGT 24ATR11 E6433	Issued	04. May 2021
MA#	MA001103322		
Package	PG-VQFN-32-9	Weight*	55.45 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.627	2.93	2.93	29331	29331
leadframe	inorganic material	phosphorus	7723-14-0	0.008	0.01		146	
	non noble metal	zinc	7440-66-6	0.032	0.06		584	
	non noble metal	iron	7439-89-6	0.647	1.17		11673	
	non noble metal	copper	7440-50-8	26.284	47.40	48.64	473979	486382
wire	noble metal	gold	7440-57-5	0.383	0.69	0.69	6909	6909
encapsulation	organic material	carbon black	1333-86-4	0.072	0.13		1295	
	plastics	epoxy resin	-	3.041	5.48		54840	
	inorganic material	silicondioxide	60676-86-0	20.833	37.57	43.18	375678	431813
leadfinish	non noble metal	tin	7440-31-5	1.435	2.59	2.59	25881	25881
plating	noble metal	silver	7440-22-4	0.555	1.00	1.00	10008	10008
glue	plastics	epoxy resin	-	0.123	0.22		2225	
	noble metal	silver	7440-22-4	0.413	0.75	0.97	7451	9676
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com